



### DESCRIPTION:

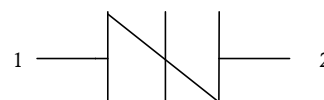
P0080BE、P0080CE are a type of semi-conduct component. They are designed to protect baseband equipment from damaging overvoltage transients.



SMB

### FEATURES:

- ✧ Excellent capability of absorbing transient surge
- ✧ Quick response to surge voltage (ns Level)
- ✧ Eliminates overvoltage caused by fast rising transients
- ✧ Moisture sensitivity level: Level 1
- ✧ Non degenerative



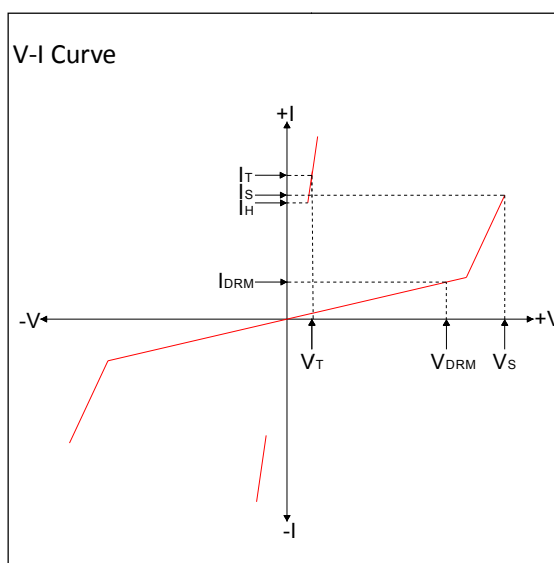
Symbol

### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub>=25°C, RH=45%-75%, unless otherwise noted)

Parameter	Symbol	Value	Unit
Storage temperature range	T <sub>stg</sub>	-60 to +150	°C
Operating junction temperature range	T <sub>j</sub>	-40 to +125	°C
Repetitive peak pulse current	I <sub>PP</sub>	P0080BE: 80	A
		P0080CE: 100	
ESD Rating per IEC61000-4-2: Contact Air		15	KV

### ELECTRICAL CHARACTERISTICS (T<sub>A</sub>=25°C)

Symbol	Parameter
V <sub>DRM</sub>	Peak off-state voltage
I <sub>DRM</sub>	Off-state current
V <sub>S</sub>	Switching voltage
I <sub>S</sub>	Switching current
V <sub>T</sub>	On-state voltage
I <sub>T</sub>	On-state current
I <sub>H</sub>	Holding current
C <sub>O</sub>	Off-state capacitance



**ELECTRICAL CHARACTERISTICS** (T<sub>A</sub>=25℃, continued)

Part Number	I <sub>DRM</sub> @V <sub>DRM</sub>		V <sub>S</sub> <sup>①</sup> @I <sub>S</sub>		V <sub>T</sub> @ I <sub>T</sub>		I <sub>H</sub>	C <sub>O</sub> <sup>②</sup>	Marking
	μA	V	V	mA	V	A	mA	pF	
	max		max	max	max	max	min	max	
P0080BE	5	6	25	800	4	2.2	50	110	P08BE
P0080CE	5	6	25	800	4	2.2	50	130	P08CE

① V<sub>S</sub> is measured at 100KV/s

② Off-state capacitance is measured in V<sub>DC</sub>=2V, V<sub>RMS</sub>=1V, f=1MHz

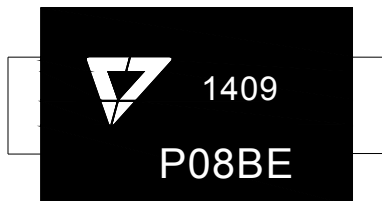
**SURGE RATINGS**

Series	I <sub>PP</sub> (A) min			
	2×10us	8×20us	10×360us	10×1000us
B	250	250	125	80
C	400	400	175	100

**ORDERING INFORMATION**

<b>P</b> Series code P: SIDACTor	<b>008</b> Median voltage	<b>0</b> 0: Bi-direction 1: Uni-direction	<b>B</b> Surge ratings:4KV(10/700μs)	<b>E</b> ESD ratings
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**MARKING**

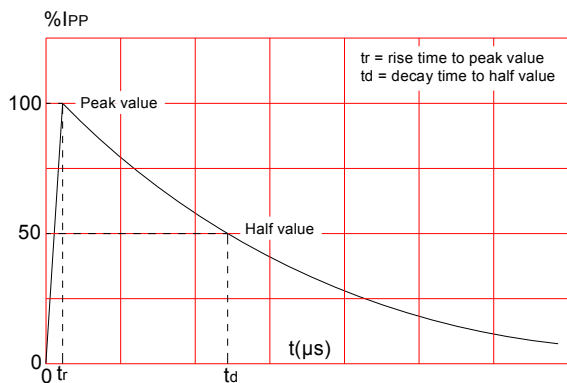


P08BE : Device Marking Code  
 1409: In ninth week, 2014

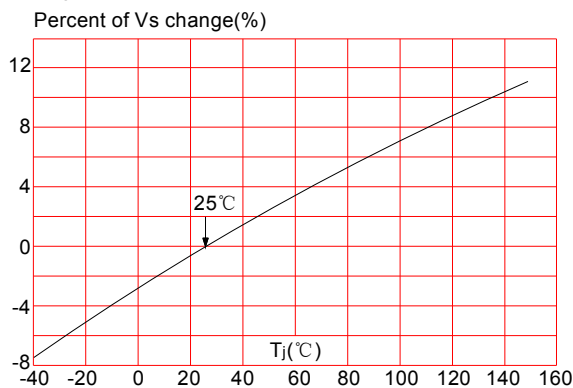
**SOLDERING PARAMETERS**

Reflow Condition		Pb-Free assembly (see FIG.2)
Pre Heat	-Temperature Min ( $T_{s(min)}$ )	+150°C
	-Temperature Max( $T_{s(max)}$ )	+200°C
	-Time (Min to Max) (ts)	60-180 secs.
Average ramp up rate (Liquid us Temp ( $T_L$ ) to peak)		3°C/sec. Max
$T_{s(max)}$ to $T_L$ - Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature( $T_L$ ) (Liquid us)	+217°C
	-Temperature( $t_L$ )	60-150 secs.
Peak Temp ( $T_p$ )		+260(+0/-5)°C
Time within 5°C of actual Peak Temp ( $t_p$ )		8-15 secs.
Ramp-down Rate		6°C/sec. Max
Time 25°C to Peak Temp ( $T_P$ )		8 min. Max
Do not exceed		+260°C

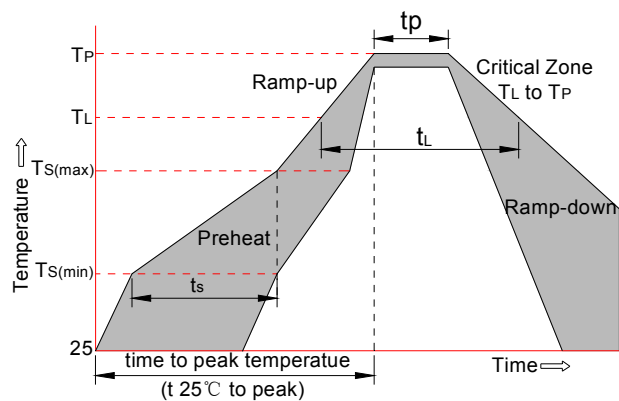
**FIG.1:** tr × td pulse waveform



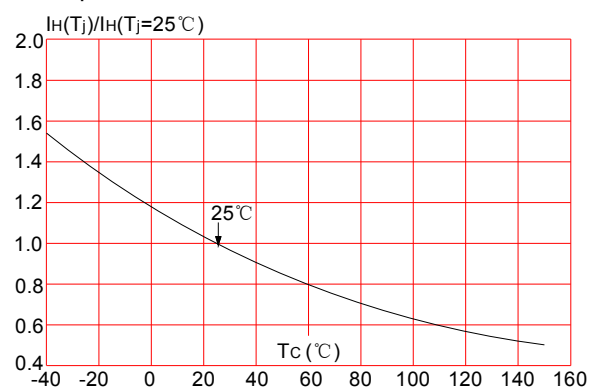
**FIG.3:** Normalized  $V_s$  change vs. junction temperature



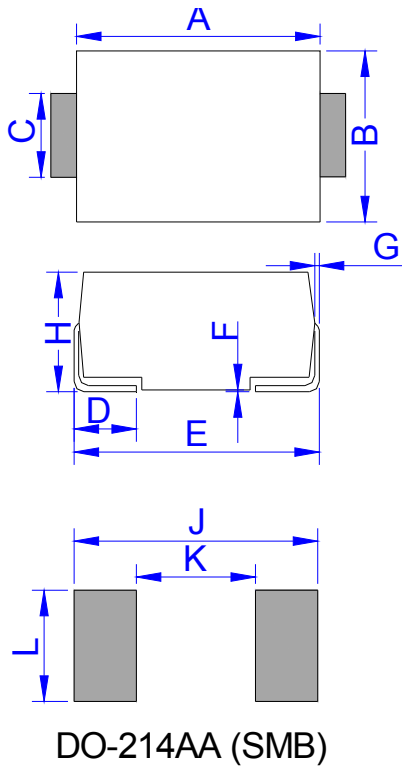
**FIG.2:** Reflow condition



**FIG.4:** Normalized DC holding current vs. case temperature

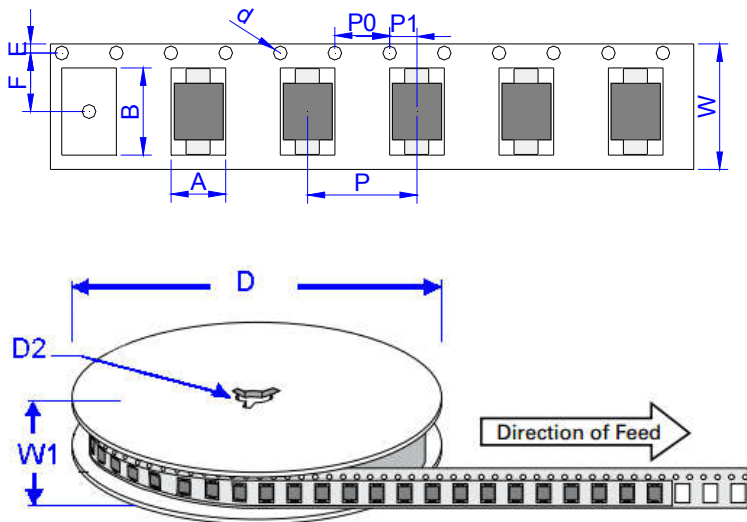


PACKAGE MECHANICAL DATA



Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.25	4.75	0.167	0.187
B	3.30	3.94	0.130	0.155
C	1.85	2.21	0.073	0.087
D	0.76	1.52	0.030	0.060
E	5.08	5.59	0.200	0.220
F	0.051	0.203	0.002	0.008
G	0.15	0.31	0.006	0.012
H	2.11	2.44	0.083	0.096
J	6.80		0.270	
K		2.60		0.100
L	2.40		0.090	


TAPE AND REEL SPECIFICATION-SMB



Ref.	Dimensions	
	Millimeters	Inches
A	3.76 ± 0.2	0.144 ± 0.012
B	5.69 ± 0.2	0.244 ± 0.012
d	1.5 ± 0.25	0.059 ± 0.004
D	330.0	13.0
D2	13 ± 1	0.512 ± 0.039
E	1.75 ± 0.2	0.059 ± 0.008
F	5.5 ± 0.1	0.222 ± 0.008
P	8.0 ± 0.2	0.315 ± 0.008
P0	4.0 ± 0.2	0.157 ± 0.008
P1	2.0 ± 0.2	0.079 ± 0.008
W	12.0 ± 0.3	0.472 ± 0.008
W1	16.8 ± 2.0	0.661 ± 0.079

OUTLINE	REEL (PCS)	PER CARTON (PCS)	REEL DIAMETERS (mm)
TAPING	3,000	48,000	330

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